

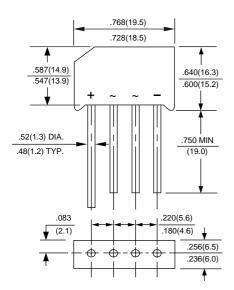
KBL02H THRU KBL10H

GLASS PASSIVATED BRIDGE RECTIFIER

Reverse Voltage - 200 to 1000 Volts

Forward Current - 4.0 Amperes

KBL



*Dimensions in inches and (millimeters)



FEATURES

- * Halogen-free type
- * Glass passivated chip junctions
- * High Surge Current Capability
- * High foward Surge Current capability
- * Ideal for Printed Circuit Boards
- * High Case dielectric strength of 1500VRMS
- Plastic Material has Underwriters Laboratory Flammability Classification 94V-0
- * High Temperature soldering guaranteed: 260°C/10seconds,0.375" (9.5mm) lead length,5lbs. (2.3Kg)tension

MECHANICAL DATA

Case: Molded Plastic

Terminals: Tin plated, solderable per MIL-STD-750,

Method 2026 **Polarity**: As marked on Body

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25 °C ambient temperature unless otherwise specified.	SYMBOLS	KBL02H	KBL04H	KBL06H	KBL08H	KBL10H	UNITS
Maximum repetitive peak reverse voltage	VRRM	200	400	600	800	1000	Volts
Maximum RMS voltage	VRMS	140	280	420	560	700	Volts
Maximum DC blocking voltage	VDC	200	400	600	800	1000	Volts
Maximum average forward output current @TA=50°C	l (AV)	4.0					Amps
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	IFSM	125					Amps
Maximum instantaneous forward voltage at 2.0 A	VF	1.1				Volts	
Maximum DC reverse current @TA=25° at rated DC blocking voltage @TA=125°	IR	5.0 1000					uA
Typical thermal resistance (NOTE 1) (NOTE 2)	R <i>θ</i> JA R <i>θ</i> JL	19.0 2.4					°C/W
Operating and Storage temperature range	TJ,TSTG	-55 to +150					°C

NOTES: (1) Thermal resistance from junction to ambient with units on 0.3 x 3.0 x 0.11" thick (7.5 x 7.5 x 0.3 cm) Al. plate

(2) Thermal resistance from junction to lead with units mounted on P.C.B. at 0.375" (9.5mm) lead length and 0.5 x 0.5" (12 x 12mm) copper pads.



RATINGS AND CHARACTERISTIC CURVES KBL02H THRU KBL10H

